

APR 27 2004

OFFICIAL

REPLY UNDER 37 C.F.R. § 1.116
EXPEDITED PROCEDURE
TECHNOLOGY CENTER ART UNIT 1762

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re PATENT APPLICATION of

BECKER et al.

Confirmation No.: 8310

Application No.: 09/424,660

Group Art Unit: 1762

Filed: January 27, 2000

Examiner: K. Bareford

For: METHOD AND DEVICE FOR CONTROLLING
THICKNESS DURING SPIN COATING (AS AMENDED)

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April 27, 2004

AMENDMENT AFTER FINAL REJECTION UNDER 37 C.F.R. §1.116Mail Stop AF
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:

In reply to the Office Action dated October 28, 2003, the period for reply being extended by a Petition for Three-Month Extension of time filed herewith, please amend the above-identified application as follows:

IN THE CLAIMS:

1-29. (Canceled)

30. (Previously presented) A method of bonding a first planar substrate to a second planar substrate by a bonding material in the form of a viscous fluid, comprising:

pumping the viscous fluid with a dosing pump to a dosing arm connected to the dosing pump and positioned over the first substrate;

Ok to enter
Kob 5/5/04